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Caruso, H.J., An Overview of Environmental Stress Screening Standards and Documents for Electronic Assemblies, No. 4, p. 15. *Updates in content and format the tabular overview of the various military standards, directives, pamphlets, and other guidance documents describing Environmental Stress Screening (ESS) published in the January/February 1987 issue of the Journal of Environmental Sciences.* (DTE Criteria and Standards, Climatics and Thermal, Shock and Vibration, Test Tailoring; PR Acquisition Policies, Stress Screening, Criteria and Standards)

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Cooper, D.W., Toward Extending Federal Standard 209(D) (Cleanrooms): Particle Concentration Limits, (Technical Commentary), No. 2, p. 14. *Describes extensions that provide greater flexibility in specifying air cleanliness levels. These allow for specifying one or more concentrations at one or more particle sizes without assuming the particle distribution of FED-STD-209D.* (CC Cleanroom Operation/Procedures, Criteria and Standards, Identification, Measurement, and Monitoring)

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Ziegahn, K.F., Effects of Airborne Pollutants on Deterioration and Aging Behavior of Materials, No. 2, p. 50. *Presents the results of a study sponsored by the German Federal Agency for the Environment on the effects of airborne pollutants.* (CC Sources and Effects; EE Air Quality)